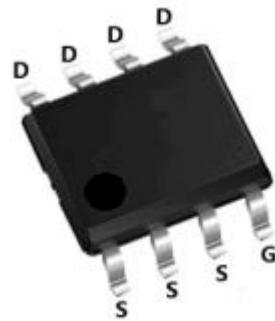
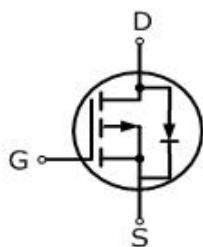


15P03P

-15 Amps,-30 Volts P-CHANNEL MOSFET

FEATURE

- -15A,-30V, $R_{DS(ON)MAX}=8\text{m}\Omega$ @ $V_{GS}=-10\text{V}/-10\text{A}$
 $R_{DS(ON)MAX}=11\text{m}\Omega$ @ $V_{GS}=-4.5\text{V}/-10\text{A}$
- Low gate charge
- Low C_{iss}
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



SOP-8 PIN CONFIGURATION

Absolute Maximum Ratings($T_C=25^\circ\text{C}$,unless otherwise noted)

| Parameter | Symbol | 15P03P | UNIT |
|--|----------------|-------------|------|
| Drain-Source Voltage | V_{DSS} | -30 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | |
| Continuous Drain Current | I_D | -15 | A |
| Pulsed Drain Current(Note1) | I_{DM} | -60 | |
| Single Pulse Avalanche Energy (Note 2) | E_{AS} | 150 | mJ |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -55 to +150 | °C |
| Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds | T_L | 260 | °C |

Thermal Characteristics

| Parameter | Symbol | 15P03P | Units |
|---------------------------------------|------------------------|--------|-------|
| Thermal resistance , Junction to Case | $R_{th(J-c)}$ | 24 | °C/W |
| Maximum Power Dissipation | $T_C=25^\circ\text{C}$ | P_D | W |

Electrical Characteristics (T_c=25°C,unless otherwise noted)

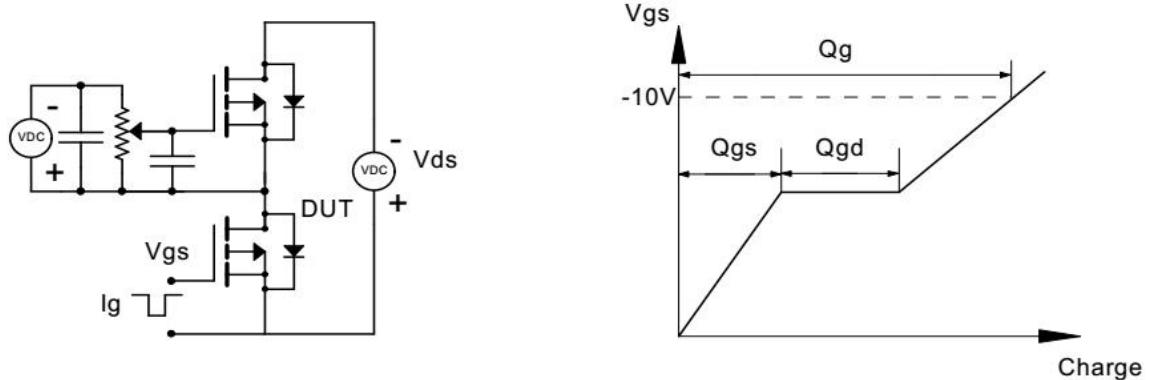
| Parameter | Symbol | Test Conditions | Min | Typ | Max | Units |
|--|---------------------|---|------|------|------|-------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V,I _D =-250uA | -30 | — | — | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =-30V,V _{GS} =0V | — | — | -1 | uA |
| Gate-Body Leakage Current,Forward | I _{GSSF} | V _{GS} =20V,V _{DS} =0V | — | — | 100 | nA |
| Gate-Body Leakage Current,Reverse | I _{GSSR} | V _{GS} =-20V,V _{DS} =0V | — | — | -100 | nA |
| On Characteristics | | | | | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} =V _{GS} ,I _D =-250uA | -1.0 | — | -2.5 | V |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} =-10V,I _D =-10A | — | 6 | 8 | mΩ |
| | | V _{GS} =-4.5V,I _D =-10A | — | 9 | 11 | |
| Dynamic Characteristics | | | | | | |
| Input Capacitance | C _{iss} | V _{DS} =-25V,V _{GS} =0V, f=1.0MHZ | — | 2303 | — | pF |
| Output Capacitance | C _{oss} | | — | 316 | — | pF |
| Reverse Transfer Capacitance | C _{rss} | | — | 287 | — | pF |
| Switching Characteristics | | | | | | |
| Turn-On Delay Time | t _{d(on)} | V _{DD} =-15V,I _D =-20A, V _{GS} =-10V, R _G =3.7 Ω | — | 12 | — | ns |
| Turn-On Rise Time | t _r | | — | 4 | — | ns |
| Turn-Off Delay Time | t _{d(off)} | | — | 67 | — | ns |
| Turn-Off Fall Time | t _f | | — | 37 | — | ns |
| Total Gate Charge | Q _g | V _{DS} =-15V,V _{GS} =-10V, I _D =-20A | — | 61 | — | nC |
| Gate-Source Charge | Q _{gs} | | — | 10 | — | nC |
| Gate-Drain Charge | Q _{gd} | | — | 15 | — | nC |
| Drain-Source Body Diode Characteristics and Maximum Ratings | | | | | | |
| Continuous Diode Forward Current | I _s | | — | — | -15 | A |
| Pulsed Diode Forward Current | I _{SM} | | — | — | -60 | A |
| Diode Forward Voltage | V _{SD} | I _s =-1A,V _{GS} =0V | — | — | -1.2 | V |
| Reverse Recovery Time | t _{rr} | V _{GS} =0V,I _s =-5A, dI _F /dt=100A/us,(Note3) | — | 25 | — | ns |
| Reverse Recovery Charge | Q _{rr} | | — | 23 | — | uC |

Notes

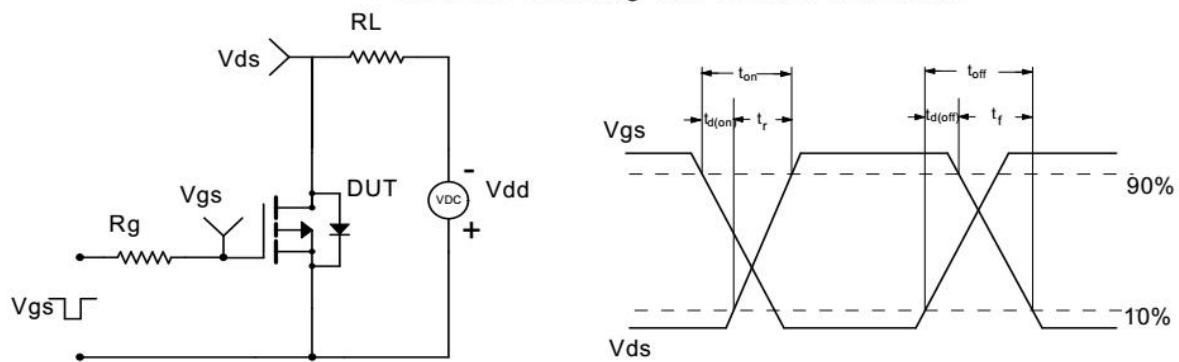
1. Repetitive Rating:pulse width limited by maximum junction temperature .
2. L=0.5mH,R_g=25 Ω , T_J=25 °C.
3. Pulse width≤300us;duty cycle≤2%.

Test Circuit and Waveform

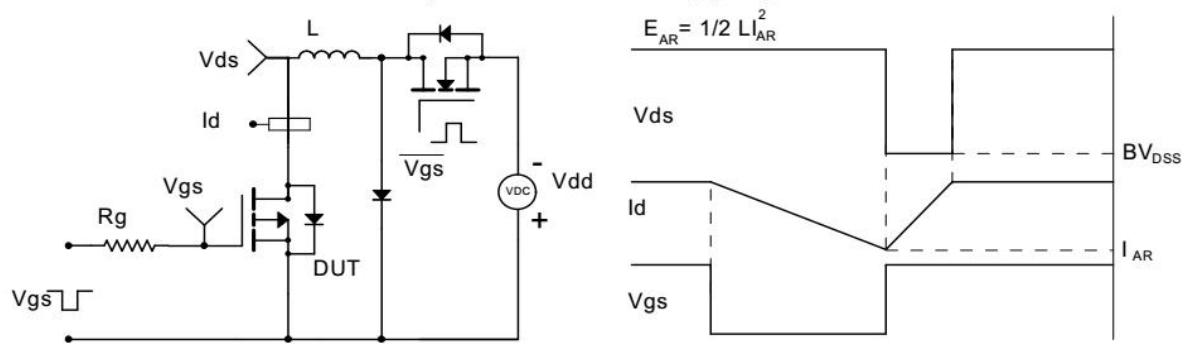
Gate Charge Test Circuit & Waveform



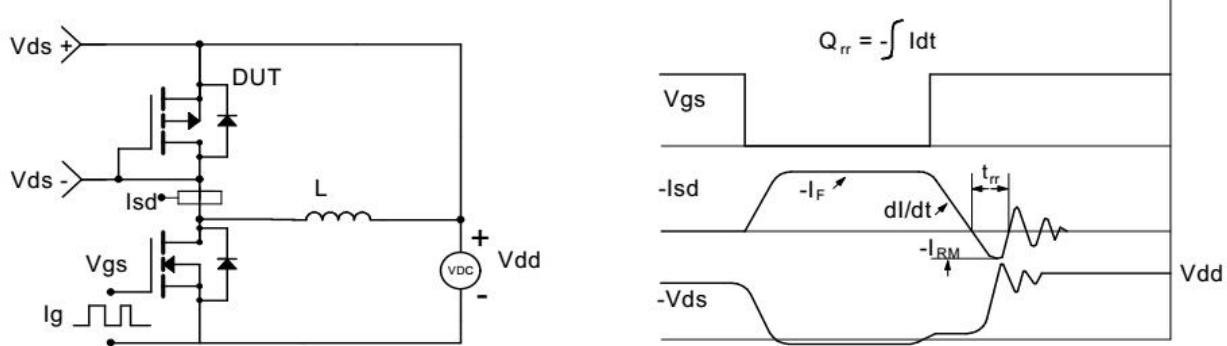
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



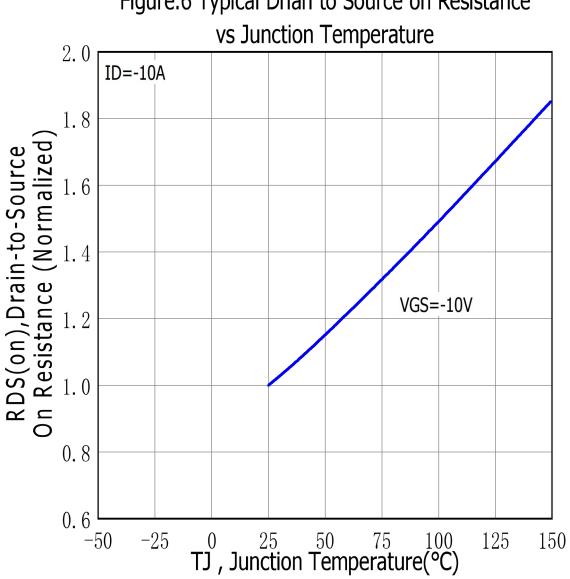
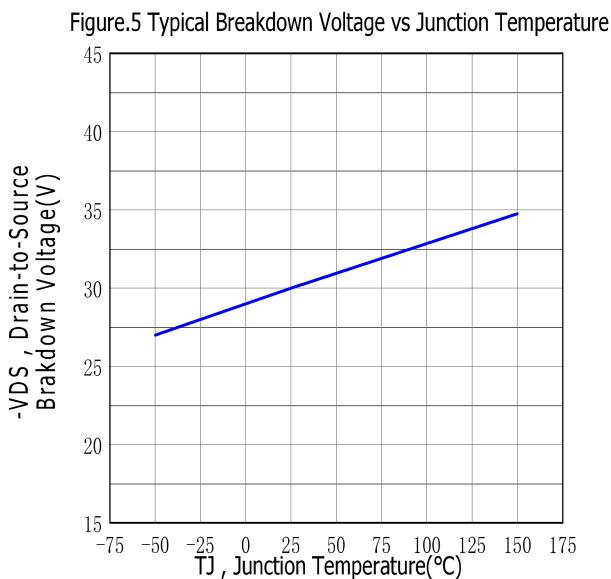
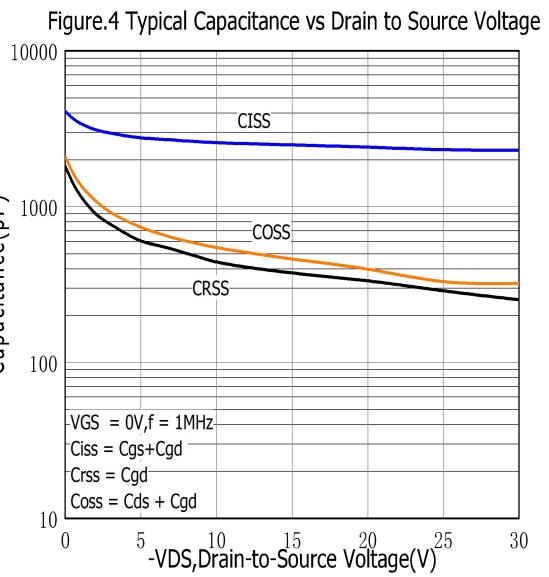
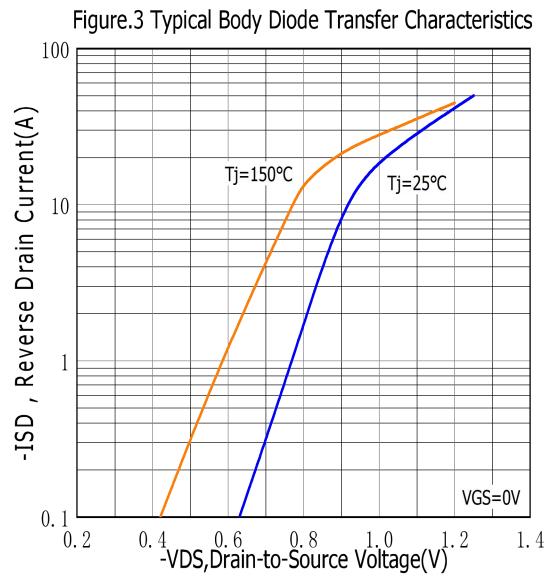
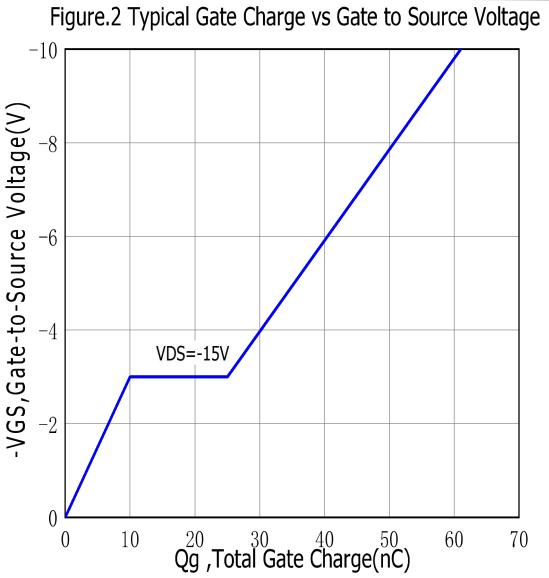
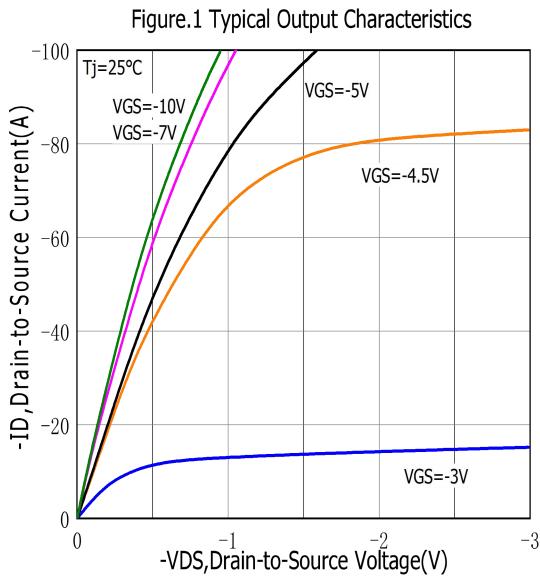


Figure.7 Maximum Forward Bias Safe Operating Area

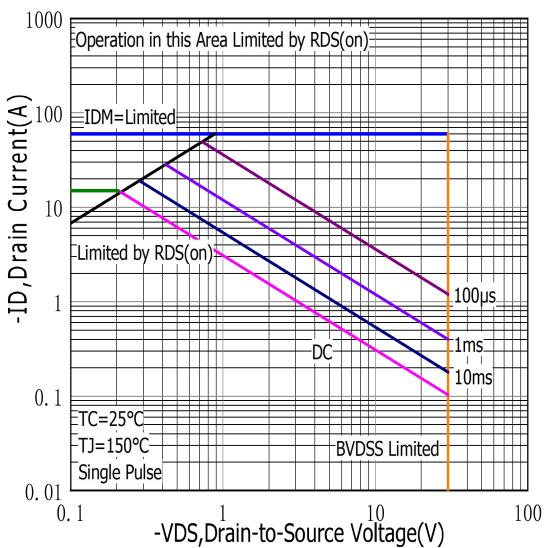


Figure.9 Maximum EAS vs Channel Temperature

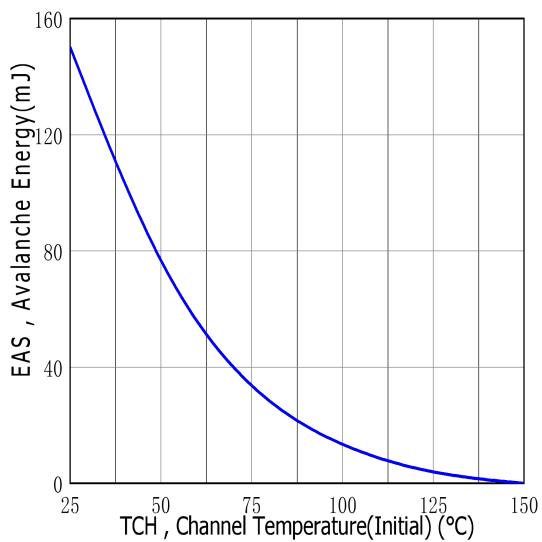


Figure.11 Maximum Effective Thermal Impedance , Junction to Case

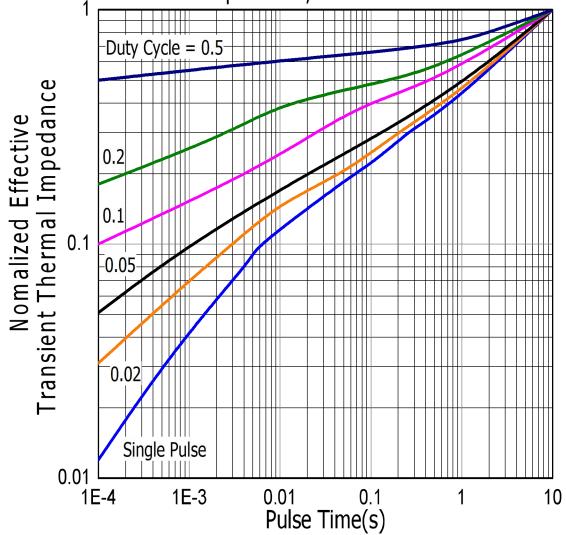


Figure.8 Typical Drain to Source ON Resistance vs Drain Current

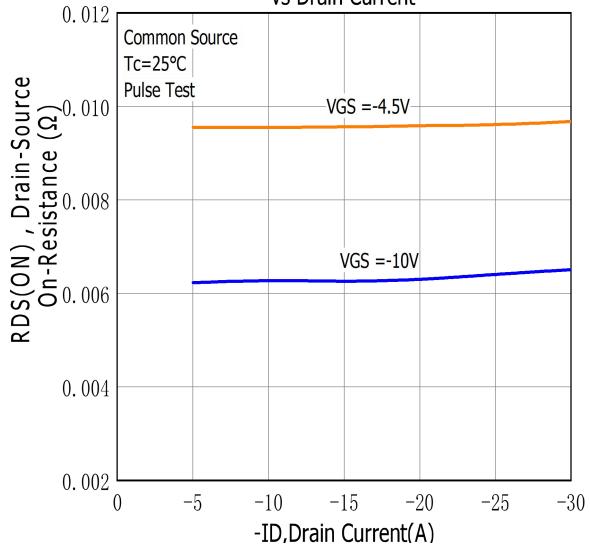


Figure.10 Typical Threshold Voltage vs Case Temperature

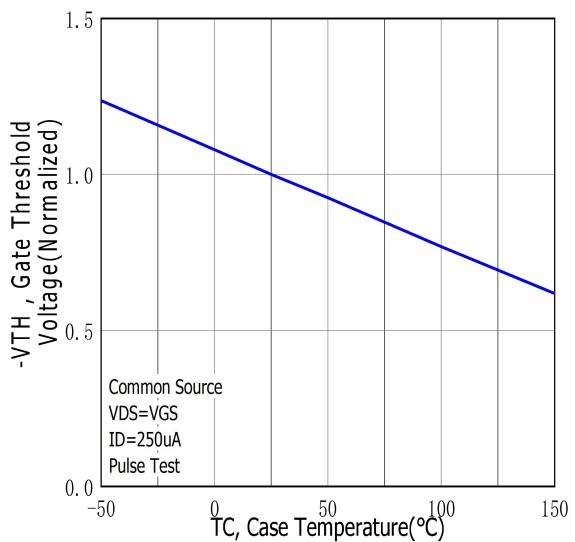
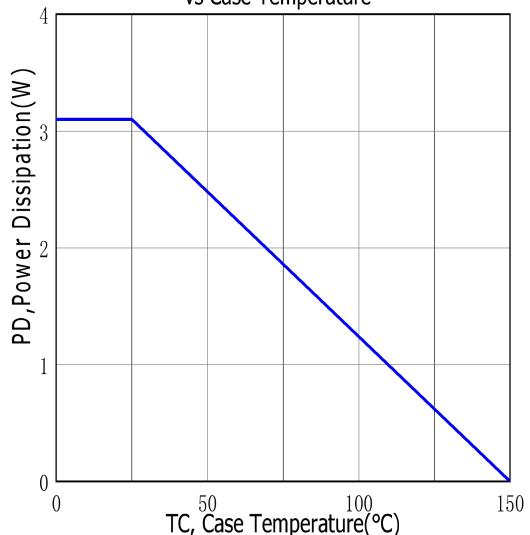
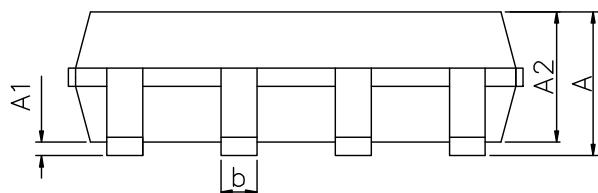
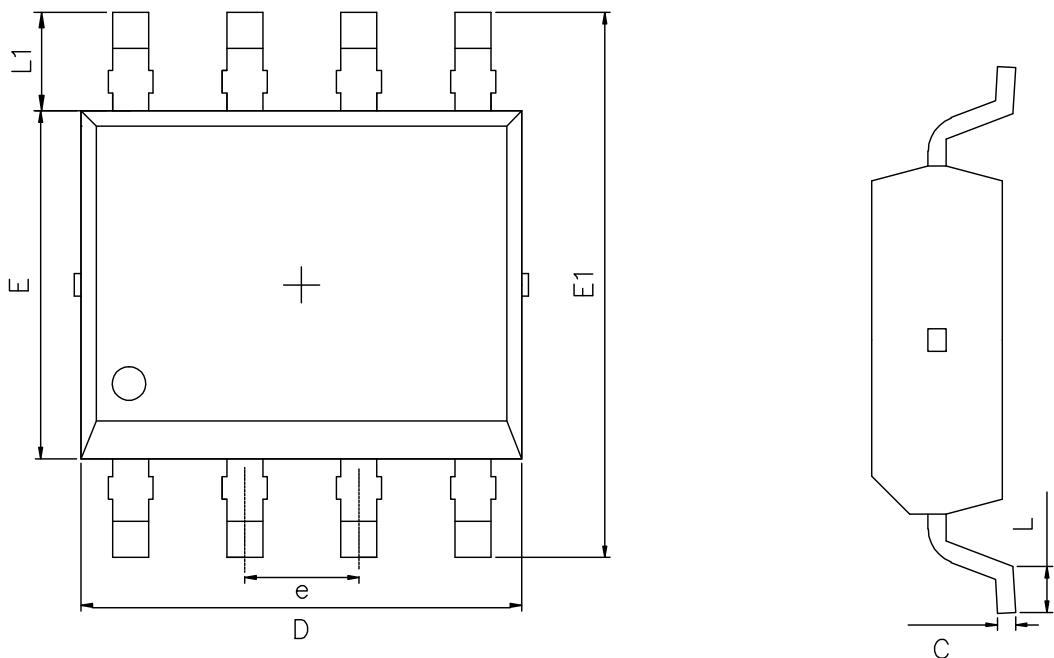


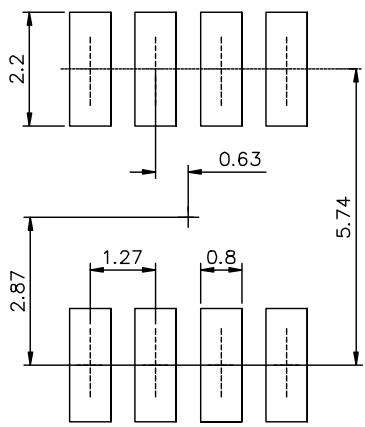
Figure.12 Maximum Power Dissipation vs Case Temperature



SOP-8 PACKAGE OUTLINE



RECOMMENDED LAND PATTERN



UNIT: mm

| | MIN | NOM | MAX |
|----|------|---------|------|
| A | 1.35 | 1.65 | 1.75 |
| A1 | 0.10 | 0.15 | 0.25 |
| A2 | 1.25 | 1.45 | 1.65 |
| b | 0.30 | 0.40 | 0.50 |
| c | 0.17 | 0.20 | 0.25 |
| D | 4.80 | 4.90 | 5.10 |
| E | 3.72 | 3.87 | 4.02 |
| E1 | 5.95 | 6.10 | 6.25 |
| e | | 1.27BCS | |
| L | 0.40 | 0.65 | 0.90 |
| L1 | 0.92 | 1.07 | 1.22 |